

Adaptive Focal Plane Array A Compact Spectral Imaging Sensor

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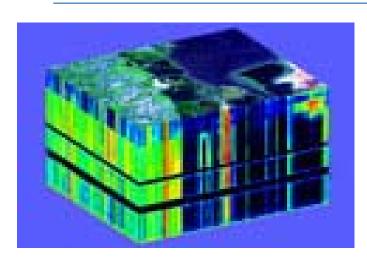
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Report Documentation Page

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Motivation for LWIR / MWIR Adaptive FPA





- Conventional hyperspectral imaging systems
 - Large and Heavy
 - Generate large volumes of data
 - Typically scanning systems
- Conventional multispectral imaging systems
 - Fixed detection wavelengths limit capability

AFPA Objective: Develop a compact spectral imaging sensor to enable enhanced target detection / ID in a device that can be deployed on SWAP-constrained platforms and provide real time information

- Wavelength tuned LWIR (8 11 μ m / $\Delta\lambda$ FWHM ~ 100 nm)
- Simultaneous pixel-registered broadband MWIR (3 5 μm)
- Spatially resolved, intelligent spectral analysis







AFPA Parameter Objectives



- MEMS tunable filter array integrated with a dual-band focal plane array
- Parameters:

- Tuning range (individual filters or checkerboard): 8.0 μ m \Rightarrow 11.0 μ m

Filter bandwidth (FWHM): 100 nm ± 20 nm @ 10.0 μm

MWIR detection band: ~ 3.5 – 5 μm (nominal)

Filter dimension: ~ 400μm center-to-center spacing

Filter optical fill factor: ≥ 50%

– FPA/ROIC: 640x480 20μm DB-FPA

Filter format: Spectral fovea (nominally 8 x 24 filters)

Operating temperature: ~ 80K

Filter tuning speed: ~ 1 msec

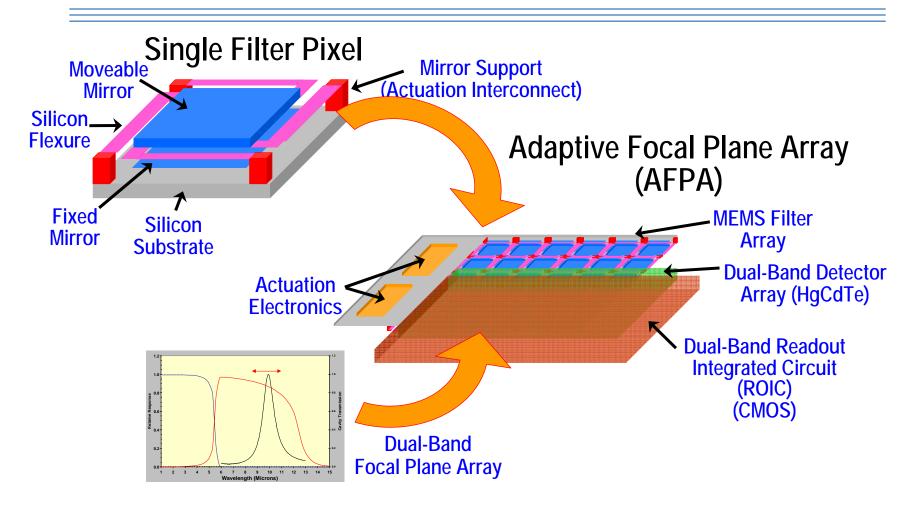






TS&I MEMS Filter / AFPA Architecture (Notional)



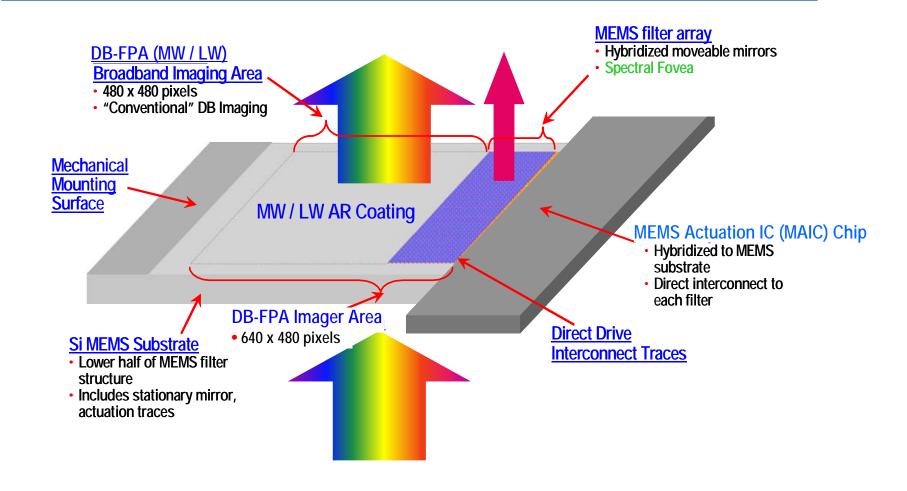






AFPA Phase II MEMS Tunable Filter Array





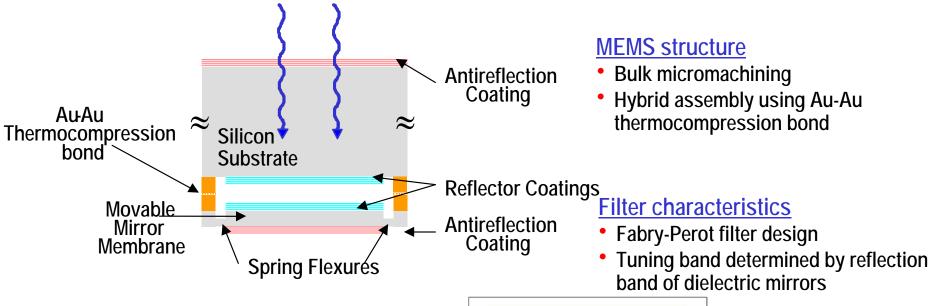




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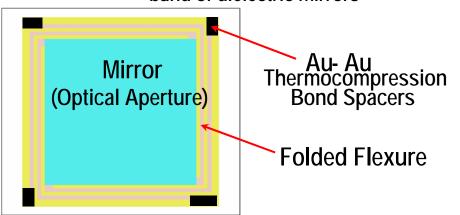
MEMS Fabry-Perot Filter Design





Filter Actuation

- Filter actuated by applying potential between moveable mirror and substrate mirror
- Displacement driven by electrostatic attraction
- Restoring force provided by Si flexure springs
- Prototype devices direct drive





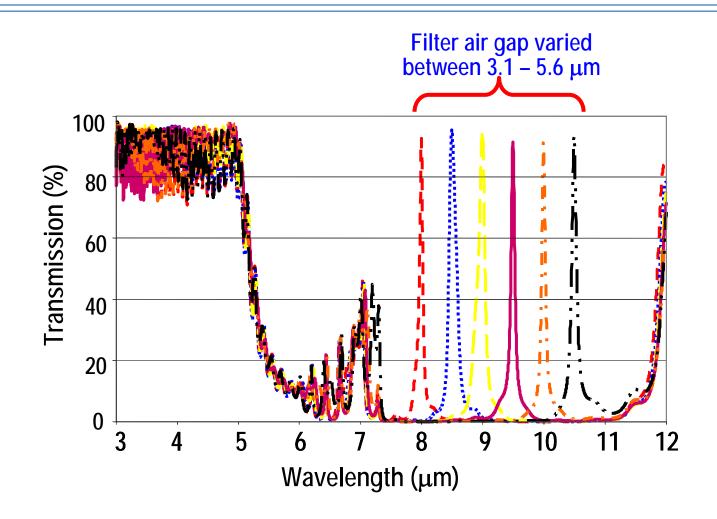


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Modeled MWIR / LWIR Spectral Performance (Transmission Averaged over F/6.5 Incident cone)



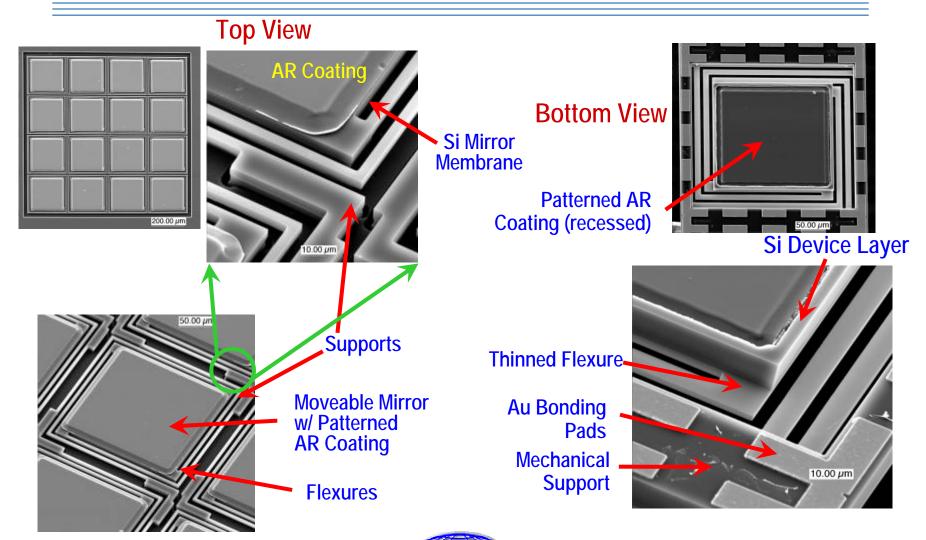






MEMS Filter SEM Images





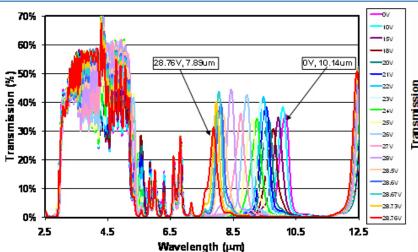


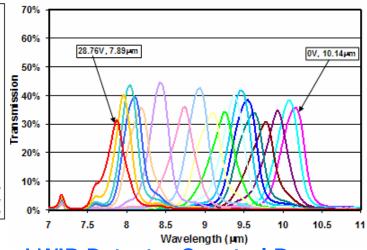


MEMS Tunable Filter Measured Optical Performance

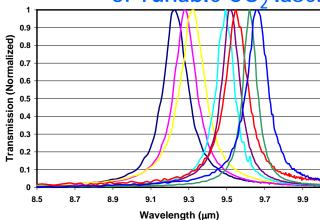








Scanned Filter Transmission of Tunable CO₂ laser

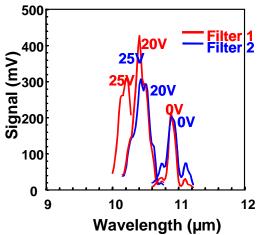


Wavelength (µm)	Bandwidth (nm FWHM)
9.23	144
9.28	138
9.32	145
9.49	108
9.52	112
9.55	145
9.62	90
9.66	129

Filter

CO₂ Laser

LWIR Detector Spectral Response with Tunable MEMS Filter





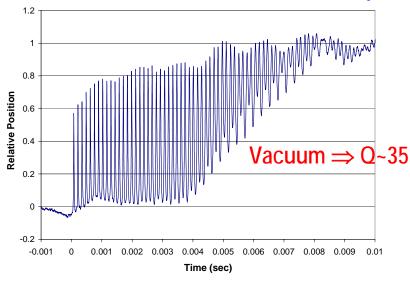


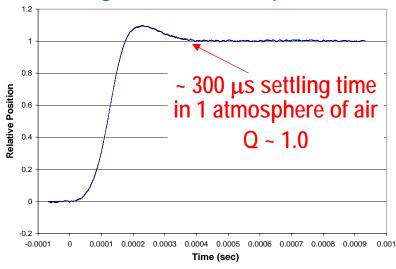
Tunable MEMS Filter Mechanical Response



- Low energy dissipation in Si MEMS structure leads to mechanical "ringing" under vacuum operation
 - 300µs in air, but may be >10's (or even 1000's) msec in vacuum
- Exploit gas damping for increased response speed
 - Requires sealed, backfilled package
 - Neon gas provides necessary viscosity for 77K operation

MEMS Filter Response to Voltage Actuation Step











AFPA Phase II Imaging Device Objectives



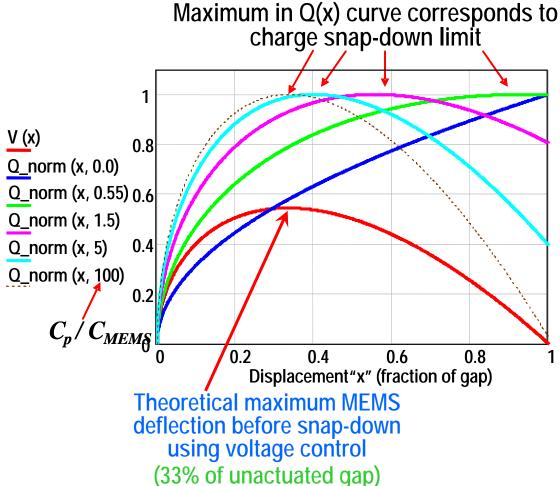
- Demonstrate full capability MEMS filter array
 - Individual, independent filter tunability
 - Extended tuning range: 8.0 11.0 μm
 - Narrower bandwidth: 100 nm ± 20 nm @ 10.0 μm
 - Design and implement CMOS MEMS Actuation IC (MAIC) for full array actuation
- Demonstrate prototype AFPA sensor
 - Imaging structure with tunable MEMS array coupled with dual-band FPA
 - Demonstrate spectral tunability in an imaging array
 - Spectral Fovea configuration
- Technical challenges
 - Overcome tuning limit imposed by MEMS snap-down phenomenon
 - Optimized optical filter design
 - Implement negative capacitance MEMS actuation to overcome parasitic
 - Provide viscous MEMS damping
 - Heterogeneous technology integration in an integrated optimal subsystem
 - Tunable MEMS filter array coupled to DB-FPA in a compact, gas-filled, optical, cryo-enclosure

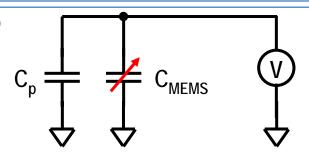




MEMS Actuation and Snap-down







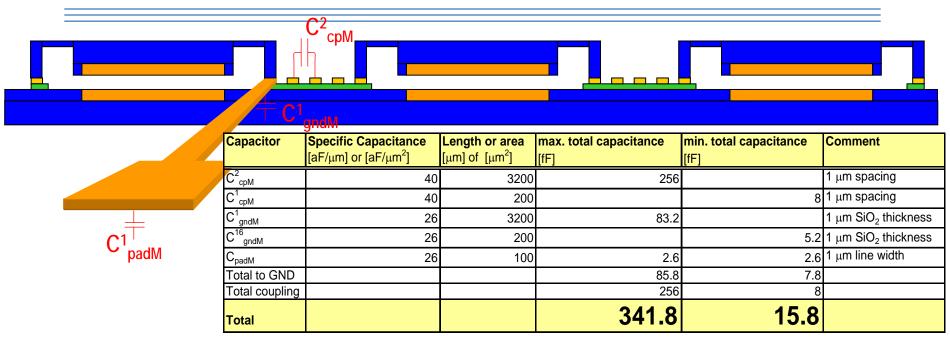
- Charge control enables tuning beyond snap-down
- Limited by parasitic capacitance between driver and MEMS device
- Negative capacitance circuit can overcome C_p
- Requires low MEMS Q to prevent oscillation past stable point
- Optimize optical coatings to maximize tuning slope / minimize demands on -C_p tuning





Primary Sources of Parasitic Capacitance





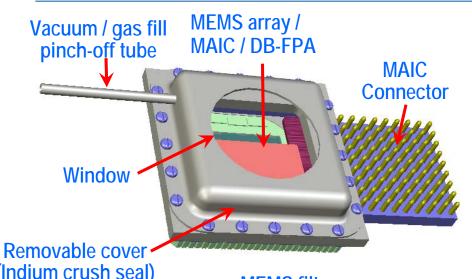
- Parasitic Capacitance dominated by coupling capacitance
 - Values depend position inside filter array
 - Largest parasitic cap determines tuning range for entire array
- MAIC will add similar capacitance
- Negative capacitance actuation circuit under development to overcome C_p limited snap-down



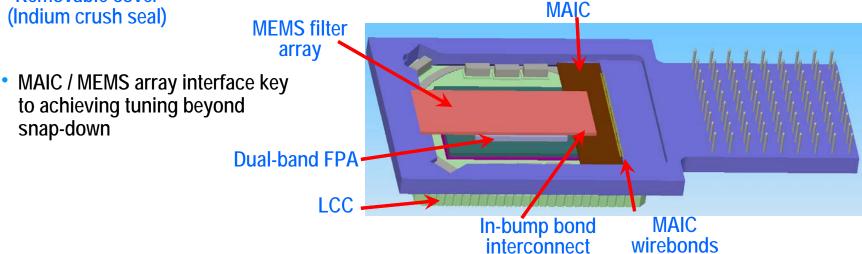


Integrated AFPA Assembly (Conceptual)





- Gas filled enclosure enables viscous gas damping of MEMS filters
- Resealable cover enables reuse and testing of MEMS filter array component







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Planned AFPA Prototype Demonstration



Lab bench level testing planned using prototype AFPA sensor

- Demonstration of LWIR spectral response tunability
 - Independent filter actuation
- Demonstration of spectral analysis capability
 - Synthetic input spectra (filtered illumination)
 - Target materials if military interest
- Demonstration of spectral imaging of scene (lab)
- Demonstration of simultaneous LWIR tuning / broadband MWIR imaging
- Future development of field-testable camera with integrated optimal spectral interrogation and analysis algorithms







Summary



- Phase I LWIR tunable MEMS filter capability demonstrated
 - Tuning range 8.0 10.0 μm
 - Filter bandwidth 90 150 nm
 - Tuning speed ~ 1 msec
 - Simultaneous broadband MWIR transmission
 - Filters as small as 280 x 280 µm
- Phase II Integrated dual-band AFPA sensor configuration established
 - Spectral fovea configuration
 - Wide tuning range (8.0 11.0 μ m) achievable using novel actuation and optimized optical design
 - Independent filter tunability
 - Sensor package combining MEMS array, CMOS MAIC, Dual-band FPA with mechanical MEMS damping
 - Optical configuration requires minimal optical imaging sensor modifications











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